

液晶模组规格书

LCM Specification

☒初定规格 Preliminary specification

☐正式规格 Official specifications

项目编号 Project No.	TFT-H078A1ZAIST7N40		
客户名称 Customer			
客户型号 Module No.			
产品描述 Product Description	TFT LCD Module 400 x 3RGB x 1280 Dots 7.8 " TFT LCD		
客 户 确 认 签 章: Signature by customer:			
☐ 小批量试产 Trial production ☐ 大批量生产 Mass production			
编 制	电子审核	结构审核	批 准
Liu.YL			

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文档修订记录 Document revision history :

版本 Version	日期 DATE	修改说明 Modify description	编制 PREPARED BY
0	2021-10-08	初次编制	Liu. YL

一、基本特征 General Feature:

项目 Item	标准值 Standard Value	单位 Unit
显示尺寸 Display Size	7.8"	—
分辨率 Number of Pixels	400 (H) x3 (RGB) *1280 (V)	—
显示区域 Active Area	59.40 (H) * 190.08 (V)	mm
外形尺寸 Outline Dimension	65.20 (H) * 201.18 (V) * 3.30 (D) <TFT>	mm
观看方向 Viewing Direction	全视角 Full 0' Clock	—
端口 Interface	MIPI 4L	—
驱动芯片 Driver IC	ST7703	—
驱动电压 Driver Condition	VCI=2.8V, IOVCC=1.8V	V
背光 Backlight	白色 LED White LED	—
触摸屏 Touch Panel	不带触摸屏 Whitout Touch Panel	—
电容触摸屏驱动芯片 CTP Driver IC	— — —	—
摸屏驱动电压 CTP Driver Condition	— — —	V
TFT 液晶工作温度 Operation Temperature	-30~85	℃
TFT 液晶储存温度 Storage Temperature	-30~85	℃



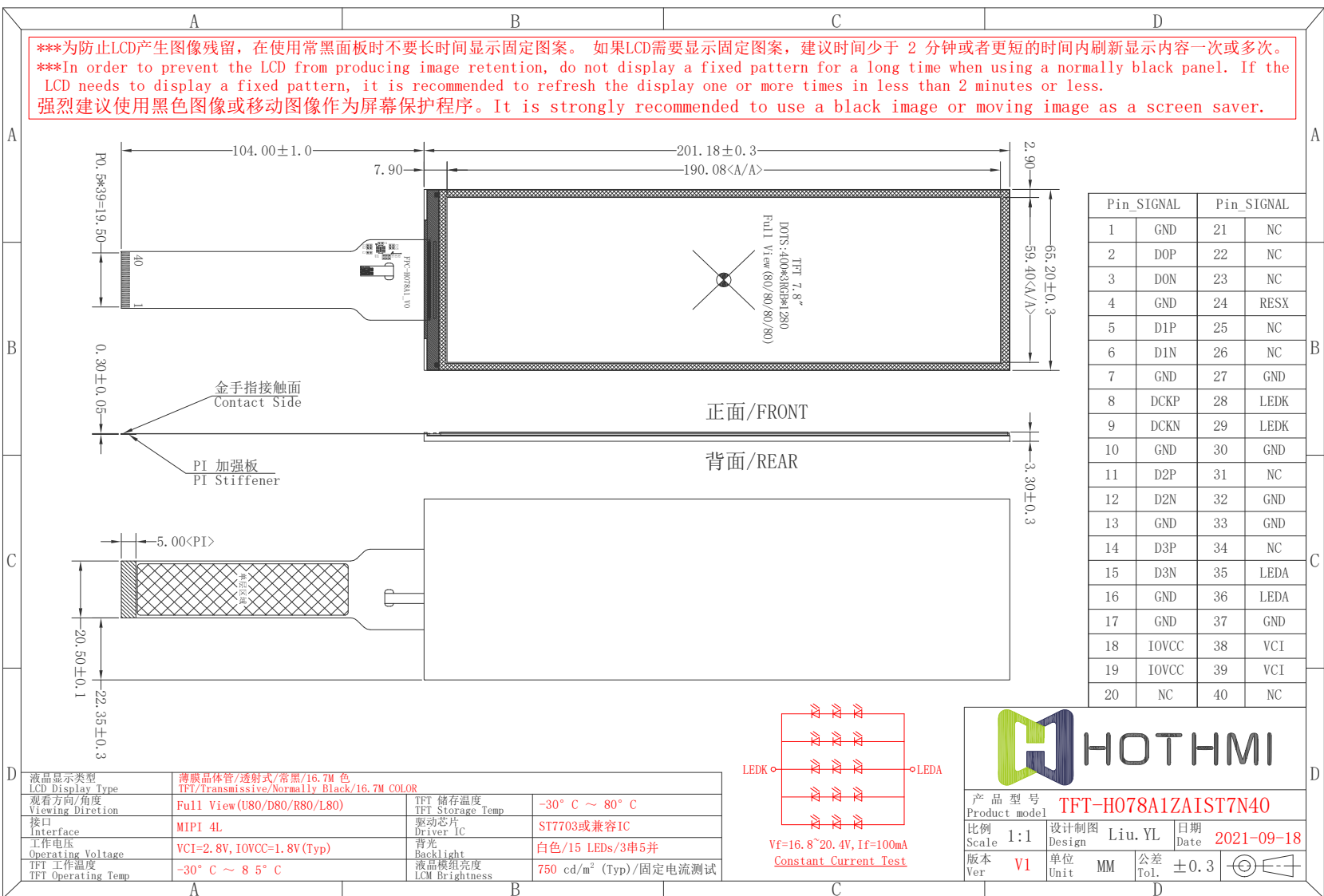
HOT-HMI

Shenzhen Hot Display Technology Co., Ltd

TFT-H078A1ZAIST7N40

2021 年 10 月 08 日
Rev:0

二、外形尺寸 Outline Dimensions

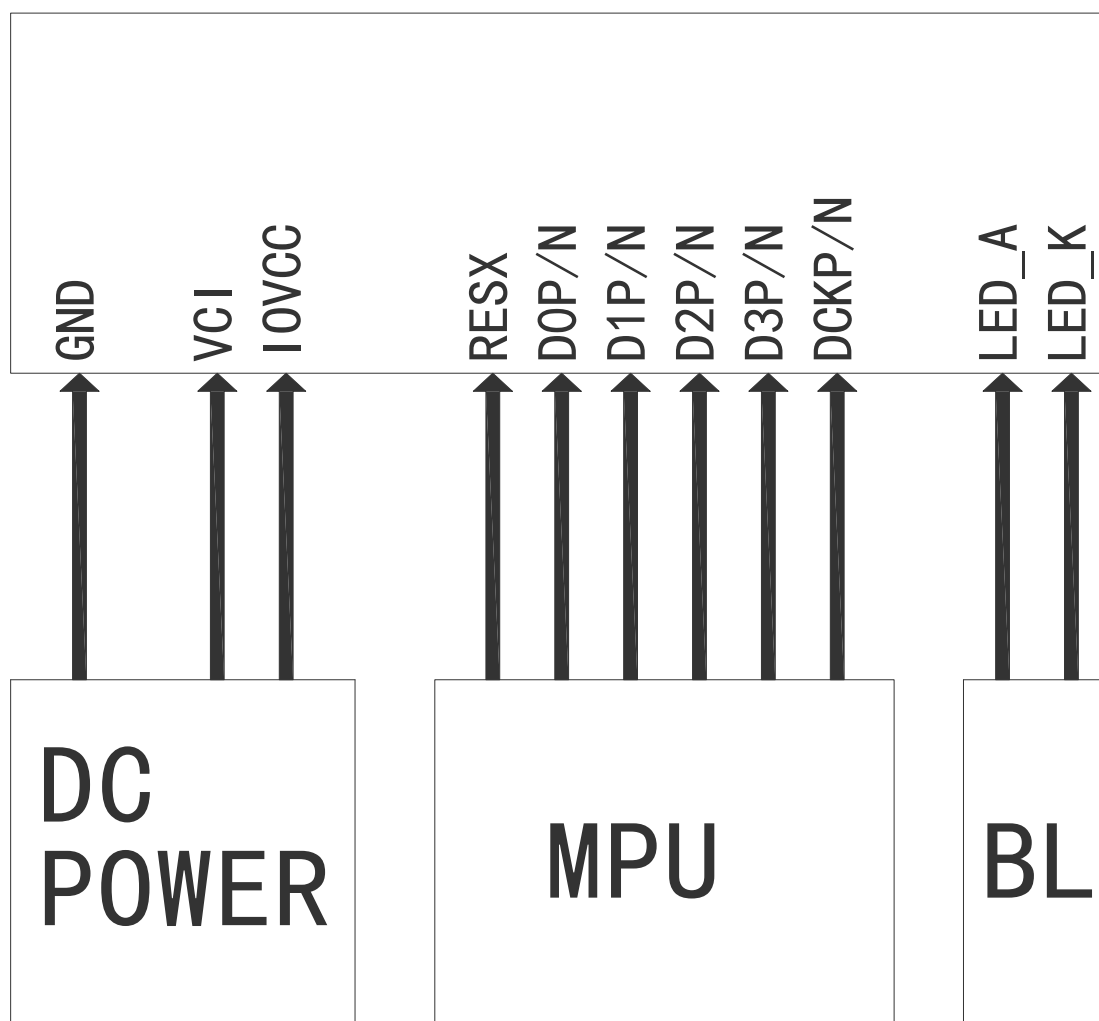


三、引脚说明 Pin Description

3.1 模组引脚说明 TFT Pin Description

引脚编号 Pin NO.	标号 Symbol	详细描述 Description
1	GND	Ground
2	D0P	High speed interface data differential signal input/output pins
3	D0N	
4	GND	Ground
5	D1P	High speed interface data differential signal input pins
6	D1N	
7	GND	Ground
8	DCKP	High speed interface clock differential signal input pins
9	DCKN	
10	GND	Ground
11	D2P	High speed interface data differential signal input pins
12	D2N	
13	GND	Ground
14	D3P	High speed interface data differential signal input pins
15	D3N	
16	GND	Ground
17, 18	IOVCC	I/O Power
20 - 23	NC	Open Pin
24	RESX	Global reset pin. Active low to enter reset state.
25, 26	NC	Open Pin
27	GND	Ground
28, 29	LEDK	Backlight cathode
30	GND	Ground
31	NC	Open Pin
32, 33	GND	Ground
34	NC	Open Pin
35, 36	LEDA	Backlight anode
37	GND	Ground
38, 39	VCI	Analog Power (2.6 ~ 3.3 V, 2.8V Type)
40	NC	Open Pin
---END---		

3.2 接线说明 Wiring instructions



四、电气特性 Electrical Characteristics

4-1 TFT 模组工作条件 TFT LCD Module Operating Conditions

项目 Item	标号 Symbol	条件 Condition	最小值 Min	典型值 Type	最大值 Max	单位 Unit
I/O 电源 I/O Power	IOVCC	—	1.75	1.8	3.3	V
数字电源 Digital Power	VCI	—	2.6	2.8	3.3	V
TFT 栅极导通电压 TFT Gate on voltage	VGH	—	10.0	—	20.0	V
TFT 栅极关断电压 TFT Gate off voltage	VGL	—	-15.0	—	-7.5	V

4-2 背光工作条件 LED back light specification

项目 Item	标号 Symbol	条件 Condition	最小值 Min	典型值 Type	最大值 Max	单位 Unit
工作电压 Forward voltage	Vt	If=20mA /1-chip	16.8	18.0	20.4	V
工作电流 Forward current	Ipn		—	100	—	mA
亮度 (带 LCD) Luminance (With LCD)	Lv	If=100mA	—	750	—	cd/m²
颜色 Luminous color	白色 White					

4-3 电容触摸屏工作条件 CTP Operating Conditions

项目 Item	标号 Symbol	条件 Condition	最小值 Min	典型值 Type	最大值 Max	单位 Unit
数字电源 Digital Power	VDD	—	2.8	3.30	3.60	V
I/O 电源 I/O Power	IOVDD	—	2.8	3.30	3.60	V
工作温度 Operation Temperature	—	—	—	—	—	℃
储存温度 Storage Temperature	—	—	—	—	—	℃

五、液晶光学规格 TFT OPTICAL SPECIFICATION

5.1 概述 Overview

光学规格的测试应在暗室（环境亮度 1lux，温度=25 ±2℃）中使用亮度计系统（测角仪系统和TOPCON BM-5）设备进行测量，测试单元应位于大约在 θ 和 Φ 等于 0° 的视角下，距 LCD 表面 50cm 的距离。显示面上测量点的中心应保持固定。测量前背光应工作 30 分钟。

The test of Optical specifications shall be measured in a dark room (ambient luminance 1lux and temperature = 25 ±2℃) with the equipment of Luminance meter system (Goniometer system and TOPCON BM-5) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0°. The center of the measuring spot on the Display surface shall stay fixed. The backlight should be operating for 30 minutes prior to measurement.

5.2 光学规格 Optical Specifications

参数 Parameter		标号 Symbol	条件 Condition	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit	备注 Remark				
视角范围 Viewing Angle Range	水平 Horizontal	⊙ 左/L	CR>10	—	80	—	Deg.	Note 1				
		⊙ 右/R		—	80	—	Deg.					
	垂直 Vertical	⊙ 上/U		—	80	—	Deg.					
		⊙ 下/D		—	80	—	Deg.					
对比度 Contrast ratio		CR	⊙ = 0°	700	900	—	—	Note2				
色域 Color Gamut		CG	CIE1931	65	70	—	%					
白色色度 White Chromaticity		Wx	⊙ = 0°	-0.03	0.300	+0.03	—	Note4 (Based on C Light)				
		Wy			0.329		—					
色彩还原 Reproduct ion of color	红 Red	Rx			—		—					
		Ry			—		—					
	绿 Green	Gx			—		—					
		Gy			—		—					
	蓝 Blue	Bx			—		—					
		By			—		—					
响应时间（上升 + 下降） Response Time (Rising + Falling)		Tr+Tf			⊙ = 0° Ta= 25℃		—		30	35	ms	Note5

注释 Note:

1. 视角是对比度大于10的角度。视角确定为相对于光轴的水平或3、9点钟方向和垂直或6、12点钟方向 垂直于 LCD 表面（见图 1）。

Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o' clock direction and the vertical or 6, 12 o' clock direction with respect to the optical axis which is normal to the LCD surface (see FIGURE 1).

2. 对比度测量应在 $\theta = 0$ 的视角和 LCD 表面的中心进行。亮度测量时，视场中的所有像素首先设置为白色，然后设置为暗（黑色）状态。（参见图 1）亮度对比度（CR）是通过数学定义的。

Contrast measurements shall be made at viewing angle of $\Theta = 0$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. (see FIGUR 1) Luminance Contrast Ratio (CR) is defined mathematically.

$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

3. 透射率是没有 APF 和没有 CG 的值。

Transmittance is the Value without APF and without CG.

4. 上表中规定的色度坐标应由所有像素首先测量的光谱数据计算为红色、绿色、蓝色和白色。测量应在面板的中心进行。

The color chromaticity coordinates specified in the above table shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

5. 电光响应时间测量应如图 2 所示，通过打开和关闭“数据”输入信号来进行。亮度从 10%变化到90%所需的时间是 T_r ，90%到10%是 T_f 。

The electro-optical response time measurements shall be made as FIGURE 2 by switching the “data” input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is T_r , and 90% to 10% is T_f .

Figure1 Measurement Set Up

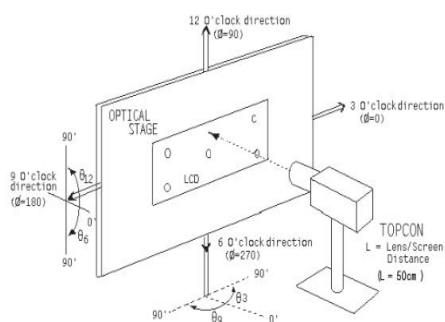


图 1

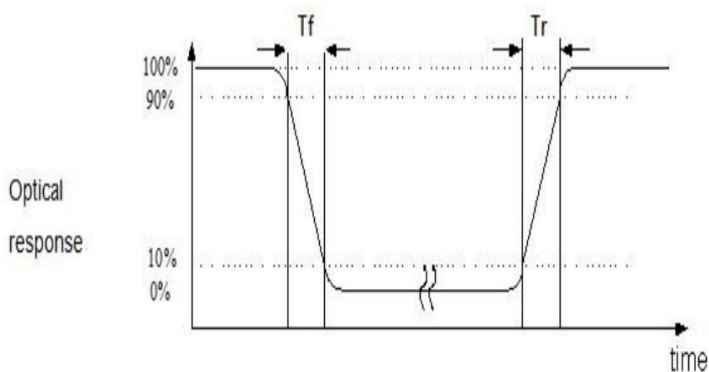


图 2

六、时序特性 Timing Characteristics

6-1 DSI 接口时序特性 / DSI Interface Timing Characteristics

A. 高速模式 High Speed Mode

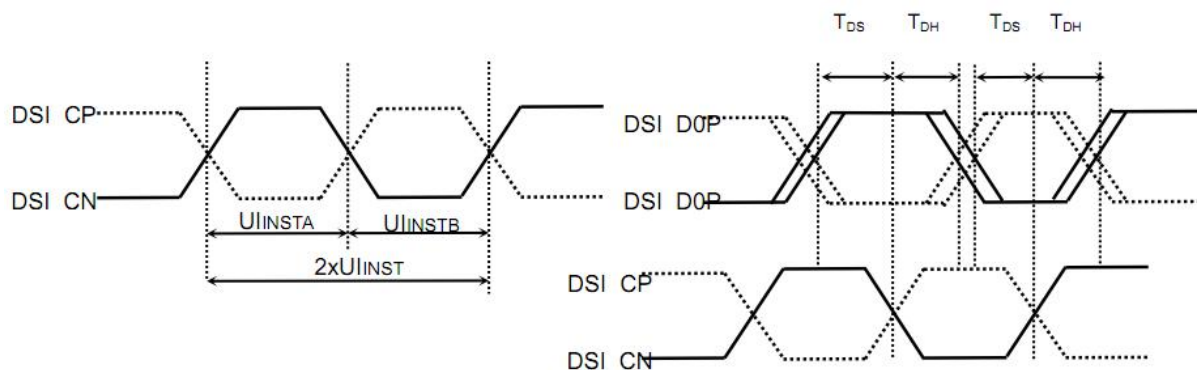


Figure 6.1: DSI clock timing Characteristics

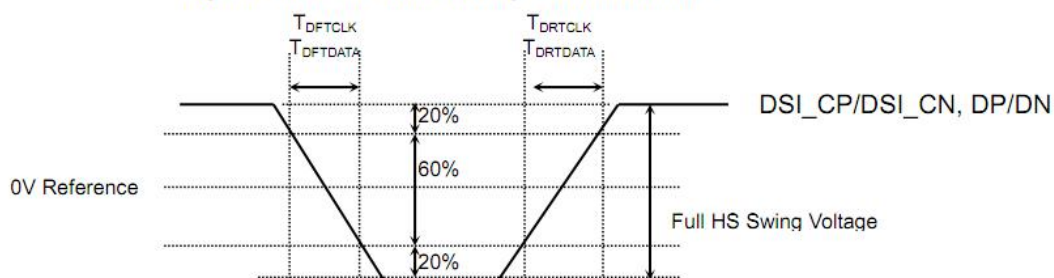


Figure 6.2: Rising and falling time on clock and data channel

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, TA = -30 to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Double UI instantaneous	2xUIINST	TBD	-	25	ns
	UI instantaneous	UIINSTA UIINSTB	TBD	-	12.5	ns
DP/DN	Data to clock setup time	T _{DS}	0.15xUI	-	-	ps
	Data to clock hold time	T _{DH}	0.15xUI	-	-	ps
DSI_CP/ DSI_CN	Differential rise time for clock	T _{DRTCLK}	150	-	0.3UI	ps
	Differential fall time for clock	T _{DFTCLK}	150	-	0.3UI	ps
DP/DN	Differential rise time for data	T _{DRTDATA}	150	-	0.3UI	ps
	Differential fall time for data	T _{DFTDATA}	150	-	0.3UI	ps

Table 6.1: DSI High Speed Mode Characteristics

B. 低功耗模式 Low Power Mode

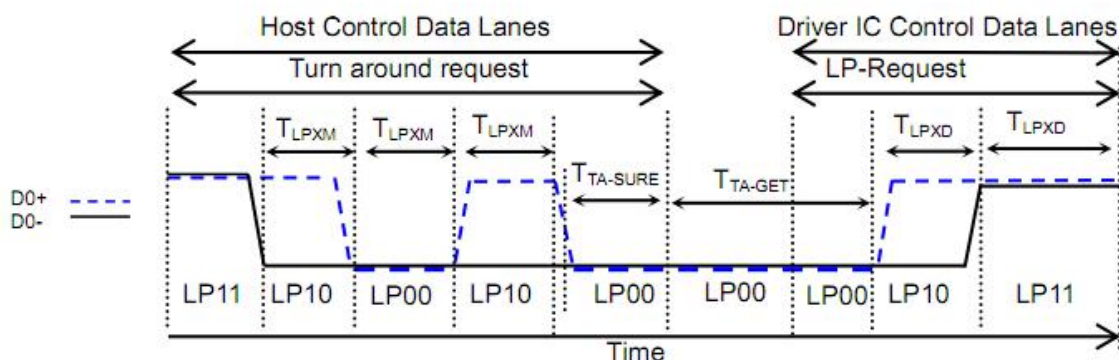


Figure 6.3: BTA from HOST to Display Module Timing

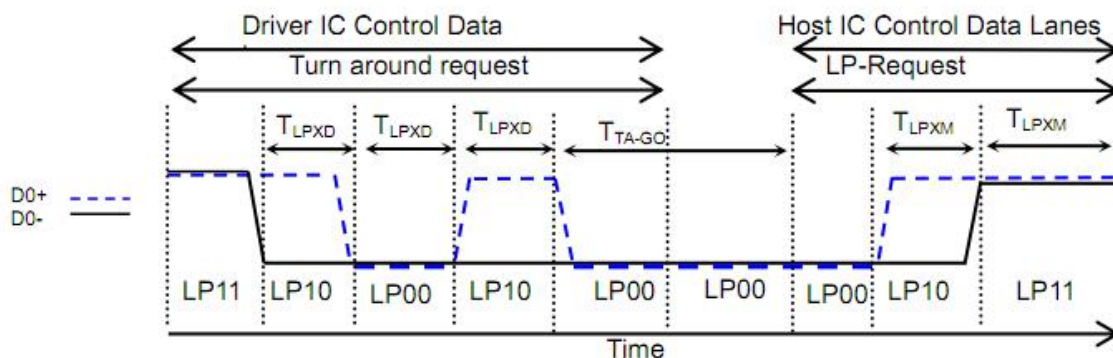


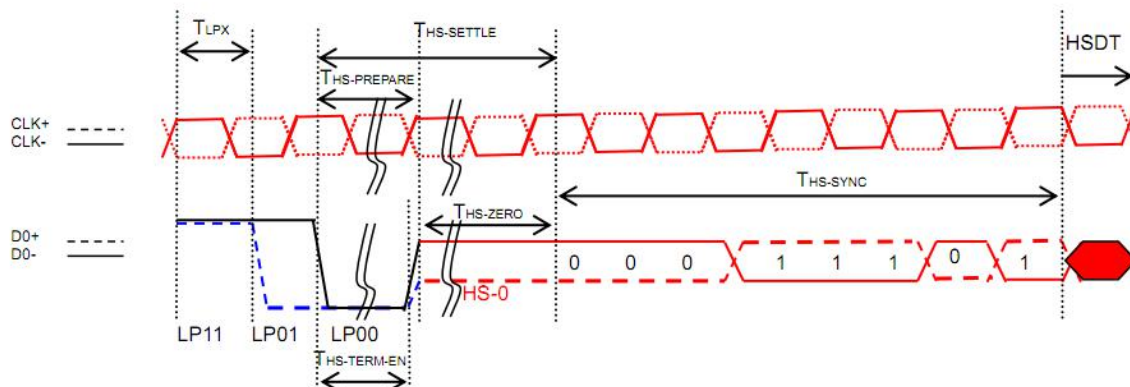
Figure 6.4: BTA from Display Module Timing to HOST

(VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.3V to 3.3V, T_A = -30 to 70°C)

Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11 Host → Display module	T _{LPXM}	50	-	-	ns
	Length of LP-00/LP01/LP10/LP11 Display module → Host	T _{LPXD}	50	-	-	ns
	Time-out before the MPU start driver	T _{TA-SURE}	T _{LPXD}	-	2xT _{LPXD}	ns
	Time to drive LP-00 by display module	T _{TA-GET}	5xT _{LPXD}	-	-	ns
	Time to drive LP-00 after turnaround request Host	T _{TAGO}	4xT _{LPXD}	-	-	ns

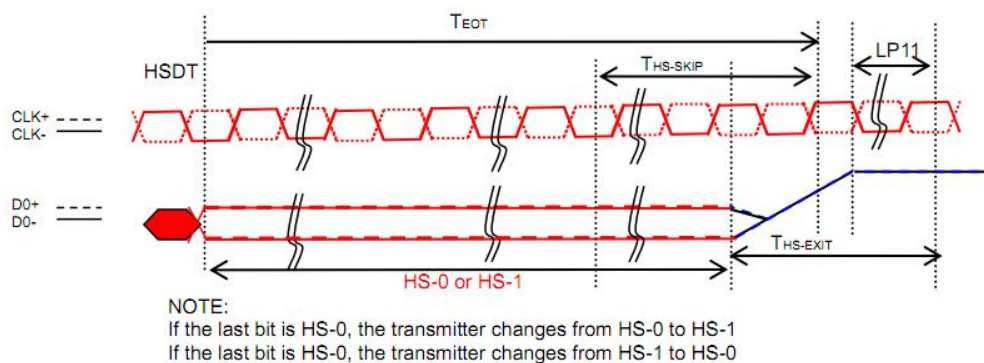
Table 6.2: DSI Low Power Mode Characteristics

C. DSI 转换 DSI BURSTS



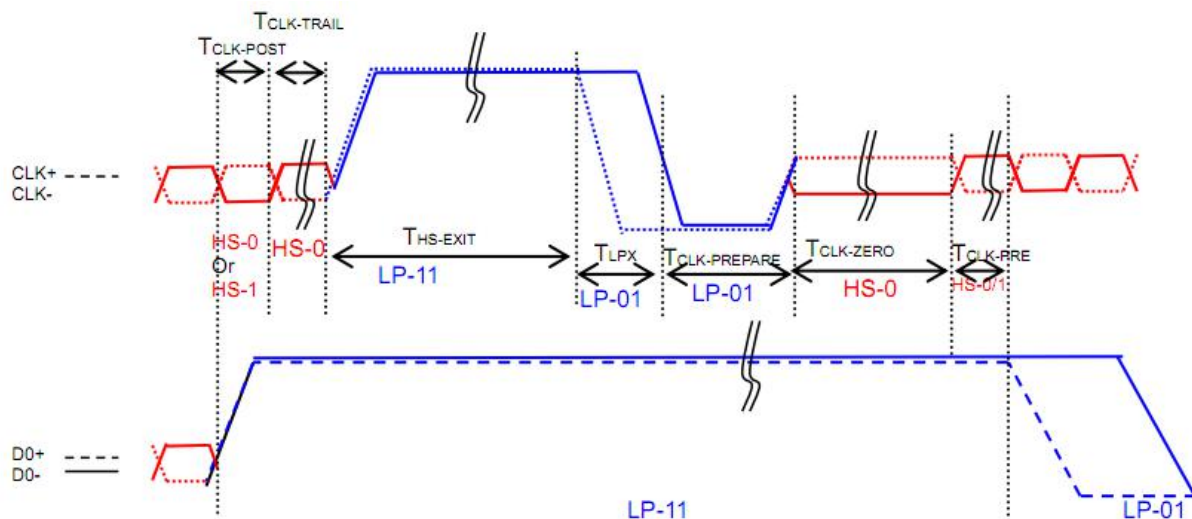
Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Length of LP-00/LP01/LP10/LP11	TLPX	50	-	-	ns
	Time to Driver LP-00 to prepare for HS transmission	T _{HS-PREPARE}	40+4UI	-	85+6UI	ns
	Time to enable data receiver line termination	T _{HS-TERM-EN}	-	-	35+4xUI	ns
	Time to drive LP-00 by display module	T _{TA-GET}	5xT _{LPXD}	-	-	ns
	Time to drive LP-00 after turnaround request Host	T _{TAGO}	4xT _{LPXD}	-	-	ns

Table 6.3: DSI Low Power Mode to High Speed Mode Timing



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_D0P/ DSI_D0P	Time-Out at Display Module to Ignore Transition Period of EoT	T _{HS-SKIP}	40	-	55+4xUI	ns
	Time to Driver LP-11 after HS Burst	T _{HS-EXIT}	100	-	-	ns

Table 6.4: DSI Low Power Mode to High Speed Mode Timing



Signal	Item	Symbol	Spec.			Unit
			Min.	Typ.	Max.	
DSI_CP/ DSI_CN	Time that the MCU shall continue sending HS clock after the last associated Data Lane has transitioned to LP mode	T _{CLK-POST}	60+52xUI	-	-	ns
	Time to drive HS differential state after last payload clock bit of a HS transmission burst	T _{CLK-TRAIL}	60	-	-	ns
	Time to drive LP-11 after HS burst	T _{HS-EXIT}	100	-	-	ns
	Time to drive LP-00 to prepare for HS transmission	T _{CLK-PREPARE}	38	-	95	ns
	Time-out at Clock Lane Display Module to enable HS Termination	T _{CLK-TERM-EN}	-	-	38	ns
	Minimum lead HS-0 drive period before starting Clock	T _{CLK-PREPARE} + T _{CLK-ZERO}	300	-	-	ns
	Time that the HS clock shall be driven prior to any associated data Lane beginning the transition from LP to HS mode	T _{CLK-PRE}	8xUI			

Table 6.5: Clock Lanes High Speed Mode to/from Low Power Mode Timing

七、可靠性测试 RELIABILITY TEST

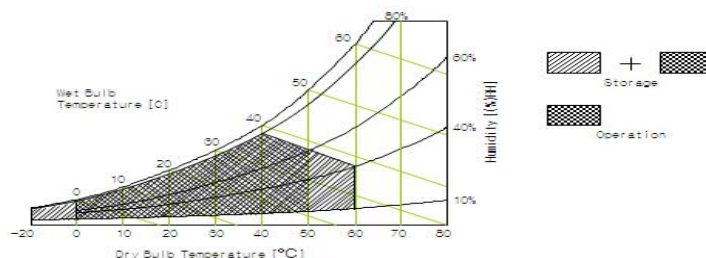
7-1 温度和湿度 Temperature and Humidity

测试项目 TEST ITEMS	条件 CONDITIONS	注释 NOTE
高温储存 High Temperature Storage	Ta=+85 o C, 240hrs	
低温储存 Low Temperature Storage	Ta=-30 o C, 240hrs	
高温运行试验 High Temperature Operation	Ta=+85 o C, 240hrs	
低温运行试验 Low Temperature Operation	Ta=-30 o C, 240hrs	
高温高湿（运行测试） High Temperature and High Humidity (Operating)	Ta=+60 o C, 90%RH, 240hrs	

注释 Note:

1. 液晶驱动电压。由于液晶材料的特性, 该电压随环境温度而变化。Liquid Crystal driving voltage. Due to the characteristics of LC Material, this voltage varies with environmental temperature.

2. 温度和相对湿度范围如下图所示。湿球温度最高应为39℃。 并且没有冷凝水。
Temperature and relative humidity range are shown in the figure below. Wet bulb temperature should be 39 °C max. and no condensation of water.



3. 产品经可靠性测试后, 仅保证功能正常, 无任何致命缺陷（不显示、线路缺陷、显示异常等）。After the reliability test, the product only guarantee function normally without any fatal defect(non-display, line defect, abnormal display etc).

4. 所有显示判断均在面板温度恢复到室温后进行 All judgments of display are performed after temp of panel returns to room temperature

5. Ta: 环境温度 Ambient temperature

7-2 冲击和振动 Shock and Vibration

测试项目 TEST ITEMS	条件 CONDITIONS
包装冲击(非操作) Packing Shock (Non-Operation)	● Shock level:980m/s² ● Waveform:1/2 Sine wave,6msec ● ±X, ±Y ±Z, each axis 1 times
包装振动(非操作) Packing Vibration (Non-Operation)	● Frequency range:8-33.3HZ ● Stoke:1.0mm ● Sweep: 10Hz-50Hz ● x, y, z 2 hours for each direction

7-3 静电放电测试 Electrostatic Discharge

测试项目 TEST ITEMS	条件 CONDITIONS
ESD (Non-operation)	150pF, 330 Ω , Contact ±4KV, Air : ±8KV. Note 1 200pF, 0 Ω , ±200V Contact test. Note 2

测量点 Measure Point:

1. LCD玻璃和金属边框 LCD glass and metal bezel
2. 连接器引脚 IF connector pins

八、处理和注意事项 HANDDLING & CAUTIONS

8-1 操作注意事项 Caution For Operation

◆由于液晶模组是玻璃材质，请勿对其施加强烈的机械冲击或静载荷。请小心搬运，因为冲击、振动和粗心的搬运可能会严重影响产品。如果从高处坠落或受到强烈冲击，玻璃可能碎了。

Since the LCM is made of glass, do not apply strong mechanical impact or static load onto it. Handling with care since shock, vibration, and careless handling may seriously affect the product. If it falls from a high place or receives a strong shock, the glass maybe broken.

◆在规定的电压限制内驱动 LCM 是必不可少的，因为高于限制的电压会导致 LCM 的寿命缩短。由直流引起的电化学反应会导致 LCM 出现不良劣化，因此应避免使用直流驱动。

It is indispensable to drive the LCM within the specified voltage limit since the higher voltage than the limit causes LCM's life shorter. An electro-chemical reaction due to DC causes undesirable deterioration of the LCM so that the use of DC drive should avoid.

◆请勿在电源开启时将 LCM 连接到系统或从系统断开连接。

Do not connect or disconnect the LCM to or from the system when power is on.

◆切勿在高温高湿的异常条件下使用 LCM。

Never use the LCM under abnormal conditions of high temperature and high humidity.

◆当暴露于剧烈的温度波动（热到冷或冷到热）时，LCM可能会受到影响；具体来说，从冷到热的剧烈温度波动会在 LCM 表面产生露水，这可能会影响 LCM 上偏振片的运行。

When expose to drastic fluctuation of temperature(hot to cold or cold to hot), the LCM may be affected; specifically, drastic temperature fluctuation from cold to hot, produces dew on the LCM's surface which may affect the operation of the polarizer on the LCM.

◆在低于工作温度范围的温度下，响应时间将极度延迟，另一方面，在高于其工作范围的温度下，LCM 可能会变黑。然而，这些现象并不意味着 LCM 出现故障或故障。一旦温度恢复到正常运行的推荐温度范围，LCM 将恢复正常运行。

Response time will be extremely delay at lower temperature than the operating temperature range and on the other hand LCM may turn black at temperature above its operational range. However those phenomenon do not mean malfunction or out of order with the LCM. The LCM will revert to normal operation once the temperature returns to the recommended temperature range for normal operation.

◆为防止LCD产生图像残留，在使用常黑面板时不要长时间显示固定图案。如果LCD需要显示固定图案，建议时间少于 2 分钟或者更短的时间内刷新显示内容一次或多次。强烈建议使用黑色图像或移动图像作为屏幕保护程序。

In order to prevent the LCD from producing image retention, do not display a fixed pattern for a long time when using a normally black panel. If the LCD needs to display a fixed pattern, it is recommended to refresh the display one or more times in less

than 2 minutes or less. It is strongly recommended to use a black image or moving image as a screen saver.

8-2 防静电措施 Caution Against Static Charge

◆LCM 使用 C-MOS LSI 驱动器，因此建议客户将任何未使用的输入端连接到 Vdd 或 Vss，上电前不要输入任何信号，并将您的身体、工作/装配区、装配设备接地 防止静电。

The LCM use C-MOS LSI drivers, so customers are recommended that any unused input terminal would be connected to Vdd or Vss, do not input any signals before power is turn on, and ground you body, work/assembly area, assembly equipments to protect against static electricity.

◆缓慢去除保护膜，保持去除方向与面板表面不垂直约 30 度，如有可能，在离子风机等 ESD 控制装置下，工作室湿度应保持在 50%RH 以上，以减少静电风险

Remove the protective film slowly, keeping the removing direction approximate 30-degree not vertical from panel surface, if possible, under ESD control device like ion blower, and the humidity of working room should be kept over 50%RH to reduce the risk of static charge.

◆避免使用合成纤维制成的工作服。 我们推荐棉质衣服或其他经过导电处理的纤维。

Avoid the use work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.

◆在处理 LCM 时，请戴上不带电材料的手套。 对地导电手腕和对地导电鞋是必需的

In handling the LCM, wear non-charged material gloves. And the conducting wrist to the earth and the conducting shoes to the earth are necessary

九、初始化代码 LCD display initialization code

```
Void Panel_Initial_code(void)
{
    //分辨率: 400 x 1280
    //接口: MIPI 4L
    #define Width 540
    #define Height 1280

    #define VFP 16
    #define VBP 21
    #define VSA 4

    #define HFP 35
    #define HBP 35
    #define HSA 35
    //=====上电复位操作=====//
    LCD_RESET=1;
    Delayms(1);          //Delay 1ms
    LCD_RESET=0;
    Delayms(10);         //Delay 10ms
    LCD_RESET=1;
    Delayms(120);        //Delay 120ms
    //=====//
    DSI_CMD(0x04, 0xB9); /// Set EXTC
    DSI_PA(0xF1);    //1
    DSI_PA(0x12);    //2
    DSI_PA(0x83);    //3

    DSI_CMD(0x04, 0xB2); /// Set RS0
    DSI_PA(0xC8);    //1
    DSI_PA(0x25);    //2
    DSI_PA(0xF0);    //3

    DSI_CMD(0x0B, 0xB3); /// SET RGB
    DSI_PA(0x10);    //1
    DSI_PA(0x10);    //2
    DSI_PA(0x28);    //3
    DSI_PA(0x28);    //4
    DSI_PA(0x03);    //5
```

DSI_PA(0xFF); //6
DSI_PA(0x00); //7
DSI_PA(0x00); //8
DSI_PA(0x00); //9
DSI_PA(0x00); //10

DSI_CMD(0x02, 0xB4); /// Set Panel Inversion
DSI_PA(0x80); //1

DSI_CMD(0x03, 0xB5); /// Set BGP
DSI_PA(0x0B); //1
DSI_PA(0x0B); //2

DSI_CMD(0x03, 0xB6); /// Set VCOM
DSI_PA(0x50); //1
DSI_PA(0x50); //2

DSI_CMD(0x02, 0xB8); ///Set ECP
DSI_PA(0x26);

DSI_CMD(0x1C, 0xBA); /// Set DSI
DSI_PA(0x33); //1 // 33 4 lane 32 3 lane
DSI_PA(0x81); //2
DSI_PA(0x05); //3
DSI_PA(0xF9); //4
DSI_PA(0x0E); //5
DSI_PA(0x0E); //6
DSI_PA(0x20); //7
DSI_PA(0x00); //8
DSI_PA(0x00); //9
DSI_PA(0x00); //10
DSI_PA(0x00); //11
DSI_PA(0x00); //12
DSI_PA(0x00); //13
DSI_PA(0x00); //14
DSI_PA(0x44); //15
DSI_PA(0x25); //16
DSI_PA(0x00); //17
DSI_PA(0x90); //18
DSI_PA(0x0A); //19

DSI_PA(0x00); //20
DSI_PA(0x00); //21
DSI_PA(0x01); //22
DSI_PA(0x4F); //23
DSI_PA(0x01); //24
DSI_PA(0x00); //25
DSI_PA(0x00); //26
DSI_PA(0x37); //27

DSI_CMD(0x02, 0xBC); /// Set VDC
DSI_PA(0x46);

DSI_CMD(0x04, 0xBF); ///Set PCR
DSI_PA(0x02);
DSI_PA(0x11);
DSI_PA(0x00);

DSI_CMD(0x0A, 0xC0); /// Set SCR
DSI_PA(0x73); //1
DSI_PA(0x73); //2
DSI_PA(0x50); //3
DSI_PA(0x50); //4
DSI_PA(0x00); //5
DSI_PA(0x00); //6
DSI_PA(0x08); //7
DSI_PA(0x70); //8
DSI_PA(0x00); //9

DSI_CMD(0x0D, 0xC1); /// Set POWER
DSI_PA(0x25); //1
DSI_PA(0x00); //2
DSI_PA(0x32); //3
DSI_PA(0x32); //4
DSI_PA(0x99); //5
DSI_PA(0xE4); //6
DSI_PA(0xFF); //7
DSI_PA(0xFF); //8
DSI_PA(0xEE); //9
DSI_PA(0xEE); //10
DSI_PA(0x77); //11

DSI_PA(0x77); //12

DSI_CMD(0x02, 0xCC); /// Set Panel

DSI_PA(0x0B); //1 Forward:0x0B , Backward:0x07

DSI_CMD(0x23, 0xE0); /// Set Gamma2.5

DSI_PA(0x00); //1

DSI_PA(0x0D); //2

DSI_PA(0x14); //3

DSI_PA(0x2C); //4

DSI_PA(0x32); //5

DSI_PA(0x3F); //6

DSI_PA(0x47); //7

DSI_PA(0x3C); //8

DSI_PA(0x07); //9

DSI_PA(0x0E); //10

DSI_PA(0x10); //11

DSI_PA(0x13); //12

DSI_PA(0x15); //13

DSI_PA(0x13); //14

DSI_PA(0x14); //15

DSI_PA(0x0F); //16

DSI_PA(0x17); //17

DSI_PA(0x00); //1

DSI_PA(0x0D); //2

DSI_PA(0x14); //3

DSI_PA(0x2C); //4

DSI_PA(0x32); //5

DSI_PA(0x3F); //6

DSI_PA(0x47); //7

DSI_PA(0x3C); //8

DSI_PA(0x07); //9

DSI_PA(0x0E); //10

DSI_PA(0x10); //11

DSI_PA(0x13); //12

DSI_PA(0x15); //13

DSI_PA(0x13); //14

DSI_PA(0x14); //15

DSI_PA(0x0F); //16

DSI_PA(0x17); //17

DSI_CMD(0x0F, 0xE3); /// Set EQ

DSI_PA(0x07); //1

DSI_PA(0x07); //2

DSI_PA(0x0B); //3

DSI_PA(0x0B); //4

DSI_PA(0x03); //5

DSI_PA(0x03); //6

DSI_PA(0x00); //7

DSI_PA(0x00); //8

DSI_PA(0x00); //9

DSI_PA(0x00); //10

DSI_PA(0xFF); //11

DSI_PA(0x80); //12

DSI_PA(0xC0); //13

DSI_PA(0x10); //14

DSI_CMD(0x40, 0xE9); /// Set GIP

DSI_PA(0xC8); //1

DSI_PA(0x10); //2

DSI_PA(0x0A); //3

DSI_PA(0x10); //4

DSI_PA(0x0E); //5

DSI_PA(0x80); //6

DSI_PA(0x81); //7

DSI_PA(0x12); //8

DSI_PA(0x31); //9

DSI_PA(0x23); //10

DSI_PA(0x4F); //11

DSI_PA(0x86); //12

DSI_PA(0x80); //13

DSI_PA(0x38); //14

DSI_PA(0x47); //15

DSI_PA(0x08); //16

DSI_PA(0x00); //17

DSI_PA(0x0E); //18

DSI_PA(0x0C); //19

DSI_PA(0x00); //20

DSI_PA(0x02); //21

DSI_PA(0x00); //22
 DSI_PA(0x00); //23
 DSI_PA(0x0E); //24
 DSI_PA(0x0C); //25
 DSI_PA(0x00); //26
 DSI_PA(0x02); //27
 DSI_PA(0x00); //28
 DSI_PA(0x8F); //29
 DSI_PA(0x94); //30
 DSI_PA(0x46); //31
 DSI_PA(0x02); //32
 DSI_PA(0x8A); //33
 DSI_PA(0x02); //34
 DSI_PA(0x88); //35
 DSI_PA(0x88); //36
 DSI_PA(0x88); //37
 DSI_PA(0x88); //38
 DSI_PA(0x88); //39
 DSI_PA(0x8F); //40
 DSI_PA(0x94); //41
 DSI_PA(0x57); //42
 DSI_PA(0x13); //43
 DSI_PA(0x8A); //44
 DSI_PA(0x13); //45
 DSI_PA(0x88); //46
 DSI_PA(0x88); //47
 DSI_PA(0x88); //48
 DSI_PA(0x88); //49
 DSI_PA(0x88); //50
 DSI_PA(0x00); //51
 DSI_PA(0x00); //52
 DSI_PA(0x00); //53
 DSI_PA(0x01); //54
 DSI_PA(0x00); //55
 DSI_PA(0x80); //56
 DSI_PA(0x38); //57
 DSI_PA(0x00); //58
 DSI_PA(0x00); //59
 DSI_PA(0x00); //60
 DSI_PA(0x00); //61

DSI_PA(0x00); //62

DSI_PA(0x00); //63

DSI_CMD(0x3E, 0xEA); /// Set GIP2

DSI_PA(0x00); //1

DSI_PA(0x1A); //2

DSI_PA(0x00); //3

DSI_PA(0x00); //4

DSI_PA(0x00); //5

DSI_PA(0x00); //6

DSI_PA(0x01); //7

DSI_PA(0x0C); //8

DSI_PA(0x41); //9

DSI_PA(0x01); //10

DSI_PA(0x02); //11

DSI_PA(0x00); //12

DSI_PA(0xF8); //13

DSI_PA(0x94); //14

DSI_PA(0x31); //15

DSI_PA(0x75); //16

DSI_PA(0x8A); //17

DSI_PA(0x31); //18

DSI_PA(0x88); //19

DSI_PA(0x88); //20

DSI_PA(0x88); //21

DSI_PA(0x88); //22

DSI_PA(0x88); //23

DSI_PA(0xF8); //24

DSI_PA(0x94); //25

DSI_PA(0x20); //26

DSI_PA(0x64); //27

DSI_PA(0x8A); //28

DSI_PA(0x20); //29

DSI_PA(0x88); //30

DSI_PA(0x88); //31

DSI_PA(0x88); //32

DSI_PA(0x88); //33

DSI_PA(0x88); //34

DSI_PA(0x23); //35

DSI_PA(0x00); //36

DSI_PA(0x00); //37
DSI_PA(0x01); //38
DSI_PA(0x28); //39
DSI_PA(0x00); //40
DSI_PA(0x00); //41
DSI_PA(0x00); //42
DSI_PA(0x00); //43
DSI_PA(0x00); //44
DSI_PA(0x00); //45
DSI_PA(0x00); //46
DSI_PA(0x00); //47
DSI_PA(0x00); //48
DSI_PA(0x00); //49
DSI_PA(0x00); //50
DSI_PA(0x05); //51
DSI_PA(0x0B); //52
DSI_PA(0x00); //53
DSI_PA(0x00); //54
DSI_PA(0x40); //55
DSI_PA(0x80); //56
DSI_PA(0x81); //57
DSI_PA(0x40); //58
DSI_PA(0x80); //59
DSI_PA(0x81); //60
DSI_PA(0x00); //61

DSI_CMD(0x01, 0x11); ///Sleep Out
DelayX1ms(250);

DSI_CMD(0x01, 0x29); ///Display On
DelayX1ms(50);

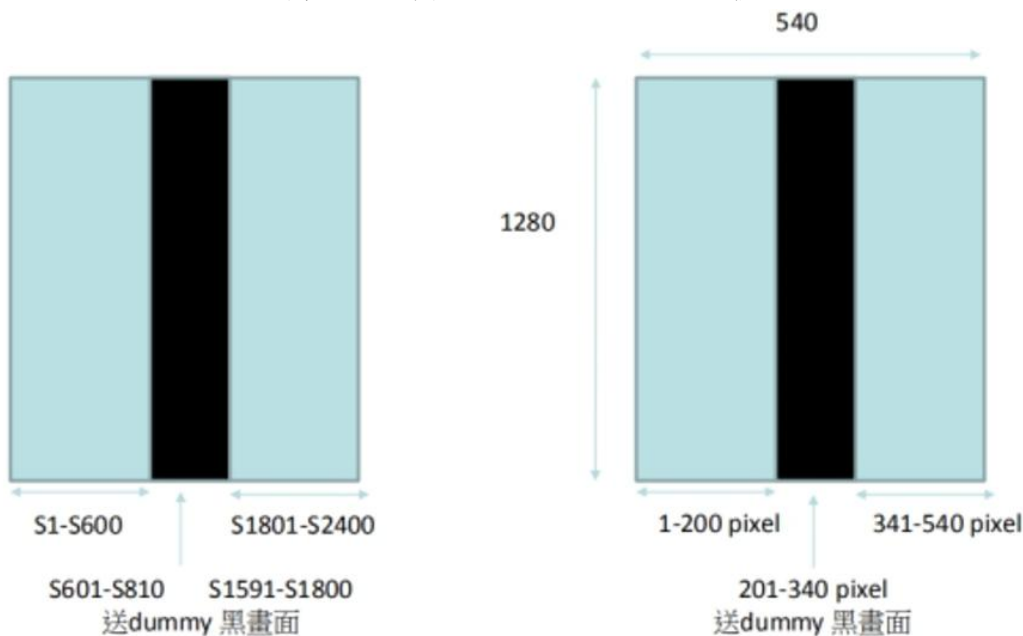
}

```
Void EnterSleep_Code(void)
{
WriteComm(0x28) //Display off
DelayX1ms(10);
WriteComm(0x10); //
DelayX1ms(120);
}
```

```
Void ExitSleep_Code(void)
{
WriteComm(0x11); // Sleep out
DelayX1ms(120);
WriteComm(0x29) //Display on
DelayX1ms(120);
}
```

注释:

- ◆因为IC设计原因，分辨率设置必需设为540*1280，设置为400*1280会显示不全
- ◆分辨率设置为540*1280时，传递显示内容或图片时需要平台按以下方式处理（中间送黑画面）



—END—